

Enabling the future of consumer electronic devices

About us Contents



Qualified experience and individual support

As a leading adhesive manufacturer in the electronics industry, we offer a wide range of customized adhesive tapes for smartphones, tablets, and other electronic devices. We work continuously to develop new products to better serve you and your customers in this fast-moving and innovative industry.

You and your suppliers are our priority. Our team of experts — from sales offices, R&D centers, and manufacturing facilities — is available globally to support you locally. In particularly, our Customer Solution Center with its technical experts is there to offer you the individual support you need. Our state-of-the-art facility with extensive equipment is at your disposal to find the adhesive solution for your needs.

Introduction	
Your complete partner	
Tapes for your success	5 –
Our commitment to sustainability	8 –
Mounting solutions	
Structural bonding solutions	1
Heat-activated films	10 –
Low-temperature reactive films	10 –
Light-curing tapes	10 —
Bond & Detach®	1
Stretch-release tapes	12 – 1
Foam tapes	1
Acrylic foam tapes	14 – 1
PE foam tapes	16 – 1
Double-sided film tapes	1
High performance profile	18 – 1
Specialized performance profile	20 – 2
Well-balanced performance profile	22 – 2
Functional solutions	
Covering tapes	2
Covering tapes	24 – 2
Electrically conductive solutions	2
Double-sided electrically conductive tapes	26 – 2
Single-sided electrically conductive tapes	28 – 2
Single-sided electrically conductive foam tapes	30 – 3
Thermal management tapes	3
Thermal management tapes	32 – 3
Display lamination solutions	
Optically clear adhesive tapes	3
Optically clear adhesive tapes	34 – 3
Global presence – Contacts	38 – 3

2 About us Contents 3

Your complete partner

Solutions that go beyond tape

Every project comes with new and individual challenges. We overcome these challenges by partnering with you to create unique and specialized products that meet and exceed your customers' expectations. Our capability goes beyond tape, as we also offer a comprehensive technical product package.



Our labs and technical experts

With our extensive experience in adhesive technology, we have developed a large portfolio of adhesive products for electronics applications.

Our technical experts will support you throughout your entire product development process and help you find the optimal solution for your requirements.



On-site support

We provide individual project support backed up by application engineers and research and development resources. Our technical experts in our Customer Solution Center offer on-site support and evaluation of your individual application under laboratory conditions.

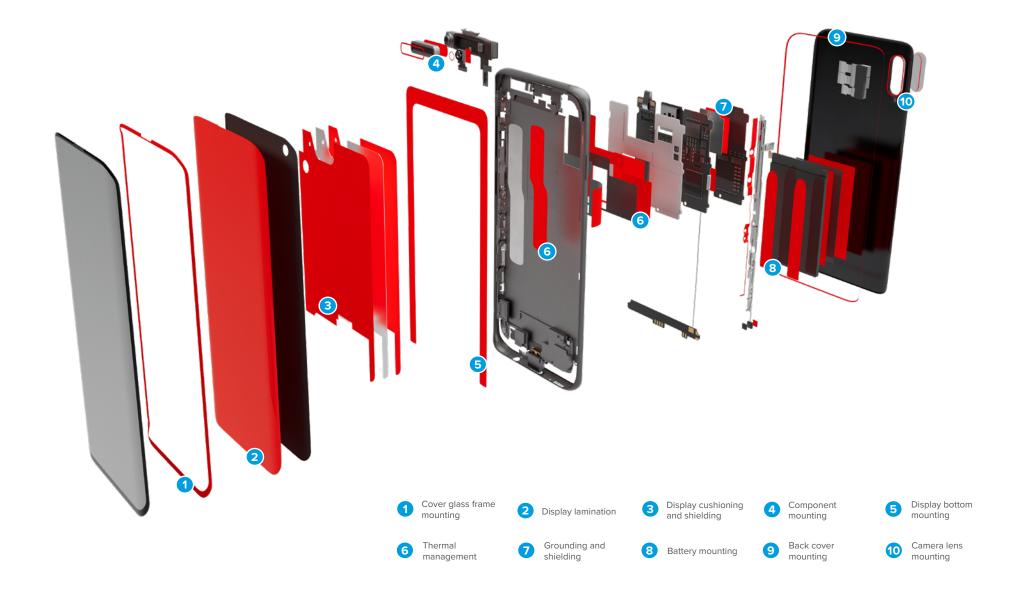


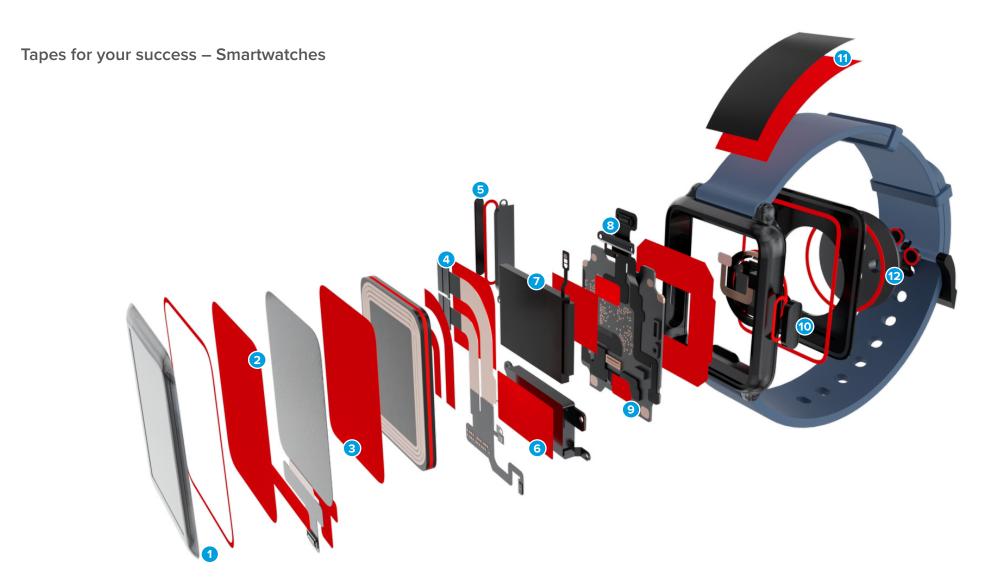
Our local experts and engineers are just a phone call away to support you with:

Process-simulation studies Assistance at your manufacturing site State-of-the-art testing equipment Tests under a wide range of environmental conditions Customized tests with customer substrates

Contact us and benefit from a strong partnership.

Tapes for your success – Smartphones





- 1 Cover lens mounting
- 2 Display lamination
- 3 Display bottom lamination
- Side key

FPC & antenna mounting

Mesh / vent mounting

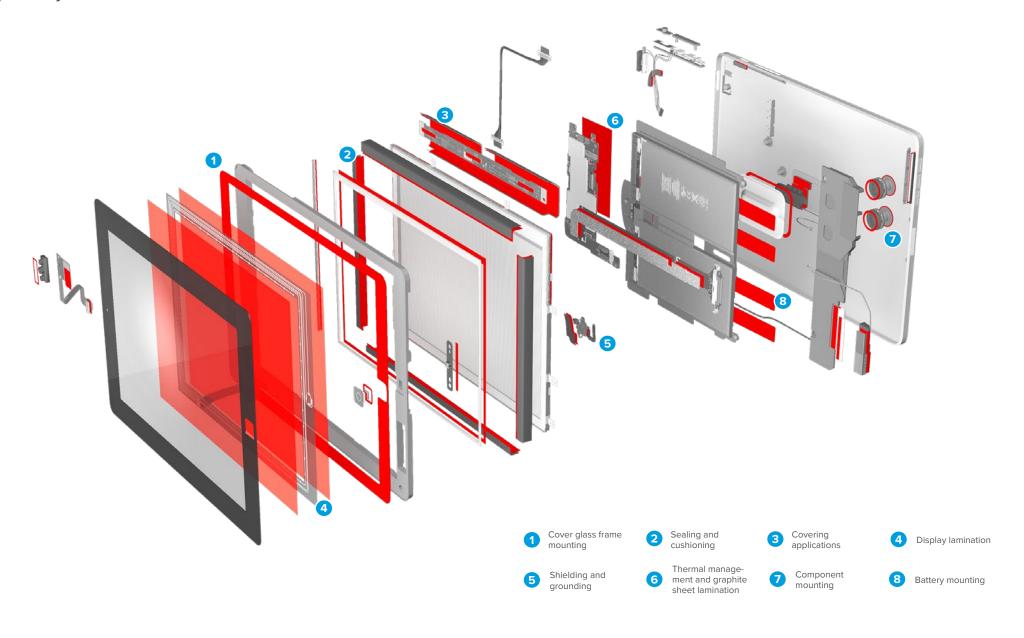
Soft goods mounting

6 Covering and insulation

- 7 Battery mounting
- 8 Grounding and shielding
- 9 Thermal management
- Side key mounting

Back cover / sensor lens mounting

Tapes for your success – Tablets





Sustainability and performance go hand in hand

Many of our customers embrace our commitment to sustainable business, and we are proud to showcase our more sustainable product developments that enable technological progress. At tesa, we believe that quality, innovation, performance, and sustainability all go together in this journey. Therefore, our assortment does not compromise the reliability and state-of-the-art bonding capabilities our customers rely on.

More than six hundred scientists, engineers, and product developers at tesa are exploring ways to improve the sustainability of our products. We are expanding our use of recycled and biobased materials across all our solutions, for example our assortment of foam, film and electrically conductive tapes for consumer electronic applications.

Additionally, we are enabling easy repairability and recyclability of electronic devices with our innovative technologies and solutions. Production-wise we focus on solvent-free production processes and technology to reuse solvents.

Want to know more about sustainability at tesa? Klick the QR code!



Reduction of emissions



Tackling the global climate crisis and accelerating positive change are central elements of our commitment. Our mission to reduce global emissions includes upstream and downstream processes as well as our own production. Green energy is a key pillar of our commitment. Since 2020, we have sourced 100 percent of our purchased electricity from renewable energy sources.

As a testimony to self-sustained clean energy procurement, we have newly installed photovoltaic systems in tesa plants Offenburg and Haiphong that cover up to 25% of the plants' electricity demand.

Responsible sourcing



Responsible procurement is the first step in the life cycle of a sustainable product.

We want to ensure that fair working conditions and human rights as well as environmental protection are in place in the supply chain. To do this, we strictly enforce supplier traceability and high transparency of our value chain: certifying our raw materials, evaluating suppliers and participating in associations.

By 2030 at least 80% of our spend will go to suppliers that are aligned with our sustainability standards. Use of recycled and bio-based materials



tesa has set itself the goal of significantly increasing product sustainability and is working on this every day.

In 2023, we have launched 8 more sustainable products for the electronics sector, and we are currently working on many more. In doing so, we are focusing on the reduction of non-recycled fossil plastics and will increasingly use recycled and bio-based materials.

We have a comprehensive carbon footprint database, and we are continuously improving our data quality. Additionally, we conduct external life cycle assessments to ensure a science-based approach. Circularity and reduction of waste



tesa will contribute to the circular economy and use resources as carefully as possible. First and foremost, this involves avoiding waste. Whenever this is not possible, we reduce it. If waste is unavoidable, we seek to reuse or recycle it by various means. By 2025, we want to eliminate all landfill disposal of production-related waste.

In 2023, we have made significant progress in reducing plastic film liner usage and initiated pilot projects with customers to collect and reuse plastic end-wall covers for log rolls.

Enable sustainability at customer



Our versatile building blocks empower customers to improve reworkability in production, enhance repairability throughout the lifespan of devices, and achieve optimal recyclability after their life cycle.

tesa has developed the famous tape tesa® Bond & Detach in the last decade which enables mechanical release with residue-free removability. And tesa is now at the forefront of revolutionizing the industry with our groundbreaking "Debonding on Demand" adhesive tapos

With an impressive portfolio of over 50 patents filed, we ensure reliable bonding performance, offer smart debonding options, and enable maximum design freedom for our customers.

8 Introduction – Our commitment to sustainability 9



The best reliability for the toughest demands

tesa® structural bonding solutions provide high bonding performance to a wide variety of substrates. They withstand the harshest conditions by combining outstanding chemical and aging resistance. The processing of these adhesive systems is simplified due to excellent die cuttability, immediate handling stability after activation, and low oozing.

Heat-activated films

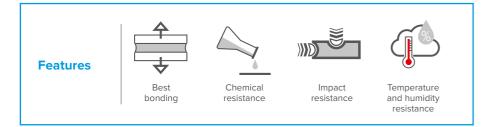
tesa® HAF is a thermosetting adhesive system. An irreversible cross-linking reaction is initiated by heat and pressure starting at temperatures above 120°C, resulting in extremely strong bonds.

Low-temperature activated films

Our low-temperature reactive films tesa® LTR and tesa® LTC have been designed for activation at moderate temperatures. The cross-linking starts at a bond-line temperature above 75°C. tesa® LTT is a low temperature thermoplastic film designed for soft goods assembly requiring low processing temperatures.

Light-curing tapes

tesa® UV epoxy and tesa® L-tape are our latest developments that will cure at room temperature when exposed to light. They achieve significantly higher bonding strengths compared to PSAs. They come with high initial tack and immediate holding strength after bonding.



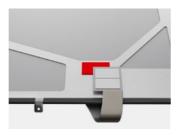
Typical applications



Component mounting



Soft goods bonding



Cover lens mounting

FPC mounting

Assortment overview

		Heat-activated films	Low-t	temperature activate	d films	Light-curing tapes		
		tesa® HAF	tesa® LTR	tesa® LTC	tesa® LTT	tesa® UV epoxy	tesa® L-tape	
Desig	n							
Color		Black, amber	Black, white, translucent	Black	Translucent	White	Translucent	
Adhe	sive	Nitrile rubber/phenolic resin	Cross-linkable polyurethane	Cross-linkable polyurethane	Thermoplastic polyurethane	Light curable	Light curable	
Activa	ation erature [°C]	>120	>75	>75	>80	Room temperature	Room temperature	
Speci featu		Temperature resistance, chemical resistance	Impact resistance, wettability on fabrics	Impact resistance, chemical resistance	High peel adhesion to fabrics	Activation at room temperature, reworkability	Activation at room temperature, impac resistance	
	10 μm	● 58469						
	20 μm	● 58477						
	25 μm							
	30 μm	● 58471 ● 8471	0 8711		0 8741			
	50 μm	● 58470	● 58480 ○ 8710 ○ 8722	● 58722	O 8742		O 8692	
Thickness	60 μm	o 8472						
Thic	80 μm	● 58473 ● 8473						
	100 μm	● 58474 ● 8474	● 58484 ○ 8714	● 58724		0 8684	O 8694	
	125 μm	● 58475 ● 8475						
	150 μm	● 58476 ● 8476	● 58486					
	200 μm	● 58478 ● 8478	● 58488				O 8698	
	300 μm		● 58489					
	Reference product	● 58474	● 58484	● 58724	○ 8742**	0 8684	O 8694	
nce	Reference substrate	SUS/SUS	PC/PC	Al/Al	PC/PC	PC/PC	AI/PC	
Product performance	Push-out [MPa]	>5.5	>5.5	>4.0	>2.5	>2.5	>3.0	
Product	DuPont [J; xy/z]	>0.5	>4.0	>1.0	n.a.	>0.5	>1.0	
-	Reliability*	••••	•••	••••	••	•••	•••	
	Chemical resistance*	••••	••	•••	•	••	••	

^{*} Assessment is done in relation to other products in this assortment

● Amber ⊙ Translucent ⊙ White ● Black

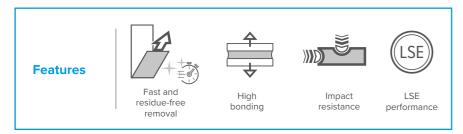
^{**} Deviating thickness



Stretch-release tapes for residue-free removability

Our Bond & Detach® solutions have revolutionized the removability of adhesives. This tape enables the permanent mounting of components with the option of removing them without residues. Bond & Detach® uses a unique adhesive technology for demanding bonding applications, that can be removed without leaving any residue by stretching it.

The patented technology was developed by tesa and offers the possibility of simple and secure debonding during the entire product life cycle – from production to end of life. It can also be used for temporary fixation during production processes or transportation. In addition, the whole assortment provides good impact resistance and bonding strength, even on LSE substrates.



Typical applications



Battery mounting in mobile devices



Removable mounting of devices or accessories



Temporary fixation of



Mounting of valuable components

Assortment overview

		tesa® 704xx/703 /706xx	tesa® 672xx	tesa® 770xx	tesa® 648xx	tesa® 705xx
De	sign					
Col	lor	White, transparent, black	White	Translucent white	White	White
Adl	hesive	Specialty	Specialty	Specialty	Specialty	Specialty
Bad	cking	-	Stretchable PU	Stretchable specialty	Stretchable specialty	-
	ecial tures	Bonding strength, easy activation	High impact resistance	Impact resistance, tear resistance	Impact resistance, tear resistance	Anti-repulsion, temp
	80 μm		o 67208**			
	100 μm	○ 70410 ● 70610	0 67210**	0 77010	O 64810**	
	150 µm	○ 70415 ● 70615	0 67215	o 77015	O 64815 O 64816	
	175 μm			0 77017		
	200 μm	○ 70420 ● 70620			0 64820	
	250 μm	o 70425 ● 70625	0 67225		o 64825	0 70525
ņ	300 μm	o 70430 ● 70630			o 64830	
CKIESS	350 μm	● 70635				
=	400 μm	○ 70440 ● 70640				
	500 μm	○ 70350● 70650	×			0 70550
	650 μm	○ 70465 ● 70665				
	800 μm	○ 70480 ● 70680				
	1,000 μm	o 70499 ● 70699				
	1,300 μm	● 70697				
D.	Reference product	o 70415 o 70315 ● 70615	o 67215	0 77015	0 64815	o 70525*
Product perrormance	Peel SUS	13.0/13.0	9.0/9.0	10.0/10.0	11.0/11.0	13.0/13.0
belle	adhesion [N/cm; initial/ultimate] PE	7.0/7.0	6.0/6.0	7.0/8.0	8.0/8.0	9.0/9.0
ioanc.	DuPont [J; xy/z]	0.7/0.3	1.1/0.8	1.1/0.8	1.0/0.7	1.0/0.7
L	Tumbler [cycles]	Upon request	>500	500	500	Upon request
	Removing force [N/cm]	4.0	5.0	4.0	4.0	6.0

^{*} Deviating thickness

O Transparent ⊙ Translucent O White ● Black

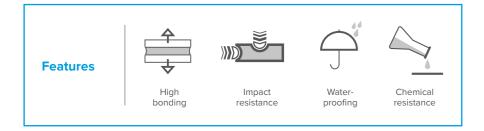
12 Mounting solutions – Bond & Detach® 13

^{**} Upon request



For applications with extreme requirements

Our acrylic foam tape assortment is especially designed for demanding applications in the electronics industry and is distinguished by its very special bonding capabilities. The high bonding performance is possible due to the tape's viscoelasticity: elastic and viscous characteristics provide inner strength and relax mechanical stresses. The use of highly innovative technologies and special acrylic adhesive systems together with the viscoelastic nature of acrylic foams create multiple benefits like impact resistance, high bonding strength, and waterproofing for electronic devices for the entire life cycle of the product.



Typical applications



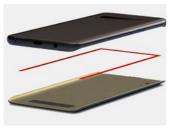


Cover glass frame mounting



Back cover mounting





Display bottom mounting



Cover lens mounting

Assortment overview

	tesa® 751xx	tesa® 754 xx/ 756 xx	tesa® 6108x	tesa® 760xx	tesa® 7588x	tesa® 757xx
				2		
esign		- Secretaria de la companya della companya della companya de la companya della co				and the same
olor	Black	Black	Black	Black	Black	Black, white
dhesive	Modified acrylic	Modified acrylic	Tackified acrylic	Tackified acrylic (66% bio-based carbon content)	Acrylic	Modified acrylic
acking	-	-	AC foam	-	-	PET
pecial atures	Outstanding impact resistance	Outstanding bonding	Easy activation, inner force resistance	Balanced performance, high bio content	Chemical resistance	Balanced performanc
50 μm		● 75405			● 75881	
100 μm		● 75410		● 76010	● 75882	● 75710
150 μm		● 75415		● 76015	● 75883	● 75715
200 μm	● 75120	● 75620		● 76020	● 75884	◆ 75720 ○ 75743
250 μm	● 75125	● 75625				● 75725 ○ 75745
300 μm	● 75130	● 75630	● 61086			● 75730
350 μm		● 75635	● 61087			
400 μm		● 75640	● 61088			
450 μm		● 75645				
500 μm		● 75650				
Reference product	● 75120	● 75620	● 61086	● 76020	● 75884	● 75720
Peel adhesion [N/cm; initial/ ultimate]	13.0/15.0	15.5/17.0	15.5/17.5	11.0/12.0	8.0/10.0	14.0/15.0
Push-out [N]	300	225	215	120	185	205
DuPont [J; xy/z]	1.4/1.2	1.3/1.0	1.6/1.3	1.0/0.8	1.4/1.2	0.9/0.8
Remov- ability*	••	•	••	••	•	•••

^{*} Assessment is done in relation to other products in this assortment

O White Black

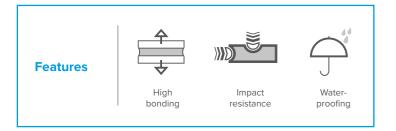
Your partner for codevelopment

We have more options available in our portfolio, and by partnering with you we can create unique and specialized products that meet your individual demands. Simply write to us or contact your local representative: electronics@tesa.com



For challenging applications

PE foam tapes have long proven their value to the electronics industry. Certain properties such as impact resistance, bonding strength, and waterproofing are offered by all series in our PE foam range. In this section we present a selection of our PE foam solutions focusing on different series' specific performance features. If you require more information than what we have provided here, please contact your local representative.



Typical applications



Cover glass frame mounting





Back cover mounting





Camera lens mounting

Display bottom mounting

Assortment overview

	tesa® 6208x	tesa® 668xx	tesa® 626xx	tesa® 6216x	tesa® 66425
Design				1.10	13.274
Color	Black	Black, white	Black	Black	Black
Adhesive	Acrylic	Acrylic	Acrylic	Special	Acrylic
Backing	PE foam	PE foam	PE Foam (partly with PET reinforcement)	PE foam	PE Foam (with PET reinforcement)
Special eatures	Gap closing, shear resistance	Anti-repulsion, impact resistance	Bonding, conformability	Fast heat removal	Cuttable for rework
150 μm	● 62082	● 66822			
200 μm	● 62084	● 66824	● 62624		
250 μm 280 μm	● 62085	● 66825	6262562645		
280 μm					● 66425
300 μm	● 62086	● 66826	6262662646	● 62166	
350 μm	● 62087				
400 μm	● 62088	● 66828			
Reference product	● 62086	● 66826	● 62626	● 62166	● 66425
Peel adhesion SUS	11.5/13.5	12.5/14.5	13.0/16.0	Provided per request	Provided per reque
[N/cm; initial/ ultimate] Push-out [N] DuPont [J; xy/z]	11/14.5	12.5/16.0	15.0/16.0	Provided per request	Provided per reque
Push-out [N]	220	252	180	180	210
DuPont [J; xy/z]	0.52/0.5	0.88/0.77	0.48/0.42	0.55/0.65	0.49/0.47
Compression force at 25% [kPa]	365	515	200	400	320
Rework- ability*	•••	•••	•	••••	•••
Anti-repulsion*	•••	•••	•	•	• •

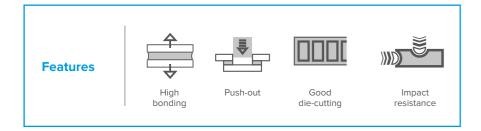
^{*} Assessment is done in relation to other products in this assortment

Black



High performance profile

Our high performance profile tapes are the spearhead of our film tapes assortment. All series in this category are characterized by superior bonding performance, which is expressed in peel adhesion, push-out and shear resistance, and high impact resistance. This assortment is therefore used for demanding applications like lens and battery mounting. The PET backings used are very well suited to being die-cut.



Typical applications







Cover glass frame mounting

Battery mounting

Component mounting

Assortment overview

	tesa® 613xx	tesa® 618xx	tesa® 6896x
Design			
Color	Transparent, black	Black	Transparent
Adhesive	Tackified acrylic	Modified acrylic	Specialty
Backing	PET	PET	PET
Special features	Push-out resistance, bonding strength	Push-out resistance, impact resistance, LSE performance	Quick bonding, LSE performance
30 μm			o 68960
50 μm	o 61305 ● 61350		O 68962
100 μm	o 61360 ● 61365	● 61865	0 68964
125 μm	o 61370 ● 61375		
150 μm	o 61380 ● 61385	● 61885	
200 μm	o 61390 ● 61395	● 61895	
230 μm	• 61345	• 61845	
250 μm	● 61325	● 61825	
300 μm	• 61315	● 61815	
Reference product	● 61365 ○ 61360	● 61865	o 68964
Peel adhesion [N/cm; SUS initial/ ultimate]	13.7/16.5	11.0/12.0	17.0/17.5
Push-out [N]	230	240	255
DuPont [J; xy/z]	0.5/0.2	0.7/0.3	0.7/0.6

O Transparent ● Black

18 Mounting solutions – Double-sided film tapes 19



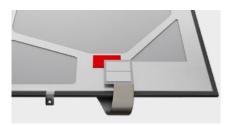
Specialized performance profile

With this assortment, we created double-sided mounting tapes with unique adhesives focusing on the special requirements of certain applications in the electronics industry. Each series within this assortment focuses on a specific property needed in the market. In this section, you will find a selection of specialized film tapes. Our capabilities go beyond what is available here. Please contact our local representatives to discuss this further.



Typical applications

FPC mounting







Rubber-foot mounting

Our specialized film tape solutions are suitable for applications with a high demand for a certain property like anti-repulsion, differential bonding performance, chemical resistance, reworkability, or light blocking. These tapes are suitable for a wide range of applications, from mounting (e.g. FPC, antenna, keypad, sensor) to processing and packaging applications.

Assortment overview

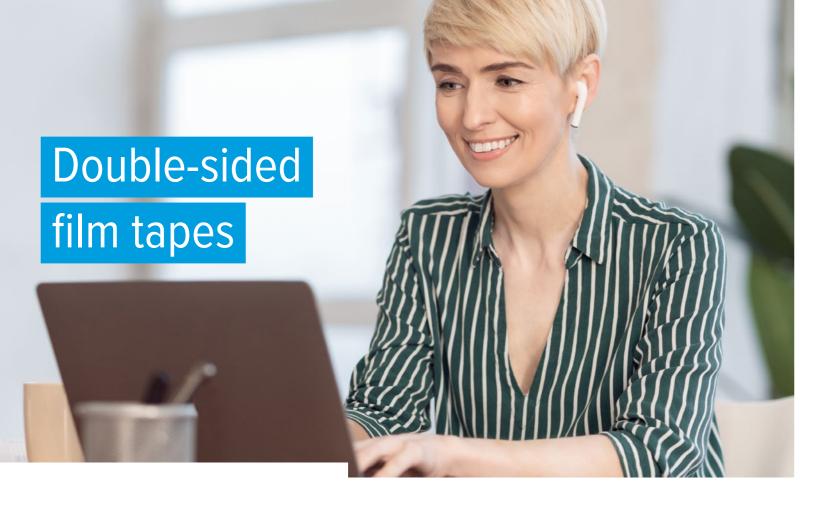
		tesa® 6693x	tesa® 615xx	tesa® 612xx/6128x	tesa® 6881x	tesa® 885x
Des	sign					Constitution of the second
Col	or	Transparent	Transparent	Black	Black	Translucent
Adh	nesive	Tackified acrylic	Silicone/acrylic	Specialty	Tackified acrylic	Tackified acrylic
Bac	king	PET	PET	PET	PET	Non-woven
	ecial tures	Anti-repulsion, easy activation	Si/Ac differential, LSE	Chemical resistance, shear	LSE, high tack, impact resistance	Temperature resistance
	30 μm	0 66930	o 61526			0 8851
	50 μm	0 66932	0 61532	● 61250/61282	• 68812	o 8853 o 8857
	80 μm				68813	
Inickness	100 μm	0 66934	0 61528	● 61210/61284	● 68814	O 8854
	140 μm		o 61529			
	150 μm			• 61215/61286		
	200 μm		0 61520	● 61220/61287	● 68817	
	250 μm			● 61288		
ē	Reference product	0 66934	o 61528	• 61210	● 68814	o 8854
rioduct periorinalice	Peel adhesion [N/cm; SUS initial/ ultimate]	10.7/11.6	Si: 4.0/4.4 Ac: 11.3/12.6	12.4/13.2	13.5/14.0	8.3/9.5
5	Push-out [N]	143	Upon request	260	130	Upon request
	DuPont [J; xy/z]	0.7/0.2	Upon request	1.1/0.7	0.9/0.5	Upon request

O Transparent ● Black O Translucent

Solutions with sustainable contribution

We are continuously increasing our range of products with sustainable aspects to help our customers achieve their own sustainability goals. We are willing to offer products that have the lowest possible impact on the environment throughout their life cycle. The use of recycled and bio-based raw materials plays a particularly important role here. In our product development, we focus on the design and integration of various more sustainable building blocks in order to provide our customers with the greatest possible flexibility in the selection of products. Reach out to us, learn more about this exciting development, and become part of it!

20 Mounting solutions – Double-sided film tapes 21



Well-balanced performance profile

tesa® balanced-performance film tapes are a proven solution for mounting and lamination applications in the electronics industry. The balanced adhesive provides very good tack and bonding performance for many general applications. The PET backing enables easy handling of the tape during converting and manufacturing processes. With thicknesses from 5 μ m to 250 μ m, this assortment offers you a broad range and excellent flexibility.



Typical applications





Battery mounting

Graphite sheet lamination

This assortment is widely used in the electronics industry for versatile mounting and lamination applications as well as for cushioning and gasket material bonding.

Assortment overview

	tesa® 49xx	tesa® 519xx	tesa® 6887 x
Design			
Color	Transparent	Black	Transparent
Adhesive	Tackified acrylic	Tackified acrylic	Bio-based acrylic (75% bio-based carbon content)
Backing	PET	PET	PCR PET (100% PCR content)
5 μm	O 4912		
30 μm	o 4983	• 51983	⊘ 0 68873
50 μm	0 4972	• 51972	€ 0 68875
80 μm	O 4980	● 51980	
100 μm	O 4982	● 51982	⊘ o 68877
125 μm	O 4928	● 51928	
140 µm	O 4942		
150 μm			⊘ 0 68878
160 μm	o 4967	• 51967	
200 μm	O 4965	● 51965	68879
250 μm	O 4926	● 51926	-
Reference product	O 4982	● 51982	O 68877
Peel adhesion [N/cm; initial/ ultimate]	11.0/11.7	11.0/11.7	12.6/12.8
Push-out [N]	230	230	Upon request
DuPont [J; xy/z]	0.5/0.2	0.5/0.2	Upon request

O Transparent ● Black

Can't find the right solution?

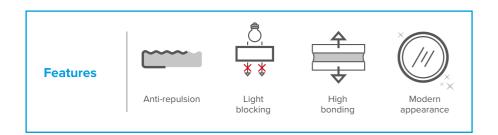
We have more options available in our portfolio, and by partnering with you we can create unique and specialized products that meet your individual demands. Simply write to us or contact your local representative: electronics@tesa.com

22 Mounting solutions – Double-sided film tapes 23



More functionality for electronic devices

Electronic components are evolving one generation after the other, just like our solutions for covering tape. Our portfolio consists of polyester and polyimide tapes.



Typical applications

Light blocking in LCD backlight unit









Insulation on PCB and FPC

Assortment overview

	tesa® 79xx	tesa® 71xx	tesa® 673xx	tesa® 663xx
Design				
Color	Matte black	Black	Matte black	Amber
Adhesive	Black tackified acrylic	Black tackified acrylic	Tackified acrylic	Tackified acrylic
Backing	Polyester	Polyester	PI	PI
Special features	Modern design, anti-repulsion	Bonding strength, dielectric insulation	Heat resistance, dielectric insulation	Heat resistance, dielectric insulation
5 μm	● 7905			
8 µm				
10 μm	● 7910		● 67310	
20 μm	● 7920		● 67320	6 6320
<u>β</u> 30 μm	● 7930		● 67330	o 66330
30 μm 50 μm	● 7950	● 7250	● 67350	
60 μm		• 7160		
80 μm		● 7180		
100 μm		● 7100		
Reference product	●7950	●7250	● 67350	● 66330
Peel adhesion [N/cm; SUS initial ultimate] Light blocking [optical density]	4.0	4.2	3.5	3.0
Light blocking [optical density]	5.7	>6	2.6	n.a.
Insulation [kV, dielectric breakdown voltage]	5.5	5.0	3.6	3.6
Anti-repulsion*	••••	Upon request	••••	••••

 $^{^{\}ast}$ Assessment is done in relation to other products in this assortment

● Amber ● Matte/Natural black

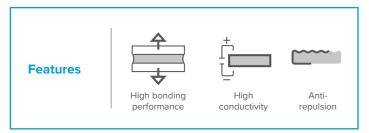
24 Functional solutions – Covering tapes Functional solutions – Covering tapes 25



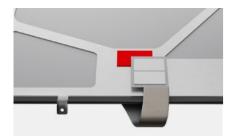
For applications requiring grounding

By offering a broad assortment of filled acrylic adhesive systems, with a balance between electrical conductivity and adhesive properties, we are able to provide the best solution for your requirements. Simply decide what is the most important for your application: bonding performance, conductivity, or a balance of both.

Our double-sided tapes are available with two different backings. The woven backing offers a higher tear resistance, very good dimensional stability, and better reworkability, while the nonwoven backing provides faster wetting, excellent conformability, and very good die cuttability.



Typical applications





FPC grounding

Component grounding

Assortment overview

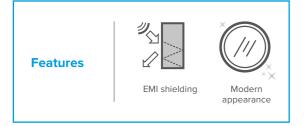
	tesa® 6025x/6026x	tesa® 6036x	tesa® 6037x	tesa® 6038x	tesa® EC HAF 5845x	tesa® 6066x	tesa® 60250
						2	
esign		1		į.	1	+[-[-]	į.
Color	Gray	Gray	Black	Gray	Black	Gray	Gray
dhesive	Conductive acrylic	Conductive acrylic	Conductive acrylic	Conductive acrylic	Conductive structural adhesive	Conductive bio-based acrylic	Conductive acry
acking	Woven, non- woven	Woven	Woven, non- woven	Woven, non- woven	-	PCR PET conductive fabric	Woven
pecial eatures	Balanced properties	High bonding strength, high conductivity	Outstanding conductivity	Outstanding bonding, repulsion resistance	Heat-activated structural bonding film, temperature and humidity resistance	Balanced properties	High appearanc quality
17 μm	© 60267						
25 μm	© 60261						
30 μm			• 60371	o 60380	• 58451		© 60250
35 μm	© 60260						
50 μm	o 60262	o 60362	• 60372	● 60381 ● 60386	◆ 58452	● 60665	
55 μm	● 60251 ● 60252						
70 μm	● 60253						
100 μm	● 60254	● 60364	• 60374	● 60384 ● 60388		● 60667	
150 μm	o 60255						
200 μm	● 60256						
250 μm	● 60257						
Reference product	● 60252 ● 60262	© 60362	● 60372	● 60381 ● 60386	● 58452	● 60667	● 60250
Peel adhesion [N/cm; initial/ ultimate]	5.4/8.3	7.0/8.0	4.3/5.6	8.0/10.0	n.a.		>5
Dynamic shear [N]	n.a.	n.a.	n.a.	n.a.	>7		
Contact resistance [mΩ.inch²]	0.05	0.01	0.01	0.06	0.05	0.05	0.05
Surface resistance [mΩ.sq]	0.2	0.1	0.1	0.3	0.5	0.2	0.2
Shielding effectiveness [-dB]	>50	>60	>50	>50	~40		

● Black ● Gray



For shielding and covering applications

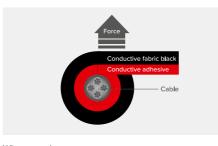
Covering and shielding applications are broad and have different requirements for conductivity, adhesion, and design. Our single-sided ECT assortment meets the latest requirements for shielding and appearance.



Typical applications







3 covering Component shielding

Wire wrapping

Assortment overview

		tesa® 6023x	tesa® 6033x	tesa® 6053x	tesa® 6031x	tesa® 6034x
Des	sign		1		Ţ	Ė
Col	lor	Matte black	Matte black	Orange	Orange	Gray
Adl	hesive	Conductive acrylic	Conductive acrylic	Conductive acrylic	Conductive acrylic	Conductive acrylic
Bad	cking	Fabric, copper	Copper	Copper	Copper	Fabric
	ecial tures	Modern, matte black design	Modern, matte black design with high shielding	Excellent bonding	Low-pressure activation, high conductivity	Low-pressure activation, high conductivity
	20 μm		● 60332			
	25 μm	● 60231				
	30 μm		• 60333	• 60537	• 60317	6 0347
ness	35 μm	● 60232				
Thickness	40 μm		● 60334			
-	45 μm	● 60238				
	50 μm			• 60538	• 60318	6 0348
	55 μm	● 60234				
	Reference product	• 60232	• 60333	• 60537	• 60317	● 60347
rmance	Peel adhesion [N/cm; SUS initial/ ultimate]	3.5/4.5	4.0	6.3/7.5	4.6/5.3	3.5/4.8
Product performance	Contact resistance [mΩ.inch²]	0.05	0.05	0.05	0.03	0.03
۵	Surface resistance [mΩ.sq]	0.2	0.1	0.2	0.2	0.2
	Shielding effective- ness [-dB]	>50	>70	>70	>70	>60

● Matte black ● Gray ● Orange

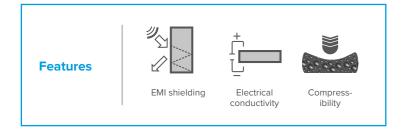
Didn't find what you were looking for?

We have more options available in our portfolio, and by partnering with you we can create unique and specialized products that meet your individual demands.



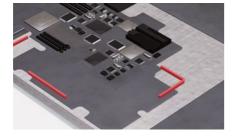
For conductive gap filling

Our single-sided electrically conductive foam tapes can be used for shielding, grounding, and filling gaps. They will provide either outstanding conformability and recovery properties or very high abrasion resistance, depending on the foam material chosen. All series in this assortment have very good shock-absorbing and cushioning properties.



Typical applications





FPC grounding

FPC Shielding

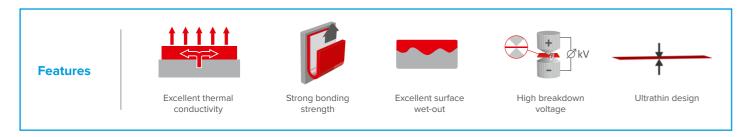
Assortment overview

		tesa® 6021x	tesa® 6068x	tesa® 6024x
Des	sign			
Col	or	Gray	Gray	Gray
Adl	nesive	Conductive acrylic	Conductive acrylic	Conductive acrylic
Bad	king	Soft foam	Ultrasoft foam	Gasket foam
	ecial	Excellent electrical conductivity	Excellent compressibility	Abrasion resistance
	200 μm	© 60213		
	300 μm	© 60214		© 60246
SS	500 μm		● 60685	● 60248
Thickness	700 μm		● 60687	● 60249
Ė	1,000 μm		© 60688	
	1,500 μm	© 60217		
	2,000 μm	© 60218		
	Reference product	© 60214	● 60685	● 60248
	Peel adhesion [N/cm; SUS initial/ ultimate]	4.8/8.3	6.0/8.0	4.8/6.3
formance	Contact resistance [mΩ.inch²]	0.03	0.03	0.03
Product performance	Surface resistance [mΩ.sq]	0.2	0.2	0.2
_	Shielding effective- ness [-dB]	>70	>60	>70
	Compression force at 50% [N/cm ²]	<50	<6	<55
	Recovery rate after 24h [%]	90	96	96

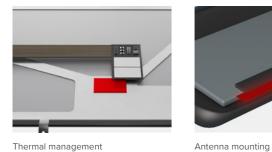


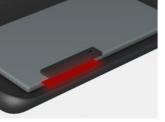
Keeping electronic devices cool

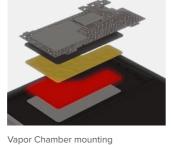
tesa® Thermal Management Tapes provides superior thermal transfer performance with excellent bonding properties. It delivers very good surface wet-out on substrates due to the transfer tape design which helps to maximize the thermal transfer efficiency in electronic devices. The available thickness range, which starts from ultrathin 10 μ m and ends at 100 μ m, offers more flexibility in the device design.

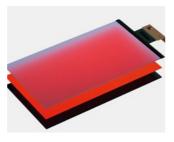


Typical applications









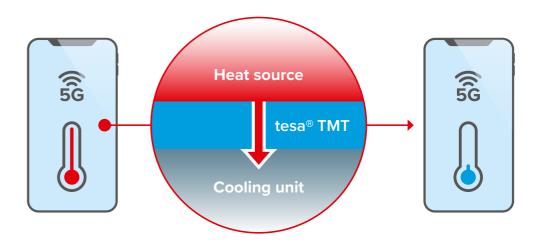
Thermal management for display

Assortment overview

		tesa® 6074x	tesa® 60735				
Des	sign						
Col	lor	White	Black				
Adl	hesive	Thermally conductive acrylic	Thermally conductive acrylic				
Spe	ecial features	Excellent thermal transfer efficiency	Excellent appearance quality for display application				
	10 μm	0 60742					
ness	30 μm	0 60743					
Thickness	50 μm	0 60744	● 60735				
_	100 μm	o 60745					
	Reference product	o 60744	● 60735				
Product performance	Peel adhesion [N/cm; SUS initial/ ultimate]	5.0	4.0				
Product p	Thermal conductivity [W/m x K]	1.0	0.4				
	Wetting [%]	84					
	Break- down voltage [kV]	2.9	1.4				

Black O White

Cooling scenario





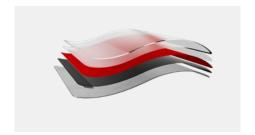
Optically clear adhesives with special features

Our comprehensive assortment is designed to provide a solution for every display application. All our materials are produced in a clean room and fulfill optically clear requirements, while also being environmentally stable and compatible with other display layers.

Typical applications



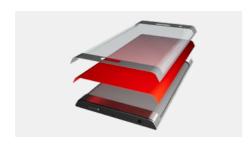
Cover lens lamination



Touch panel lamination



Lamination in VR/AR devices



3D cover lens lamination

New OCA solutions

In addition to our active assortment, we are constantly developing new adhesive solutions for displays. Our latest innovations include tesa® OCA 693xx for thinner designs and tesa® 71xx with good mura resistance for automotive display. Besides, a range of OCAs that add UV-blocking properties for polarizer less designs are under development.



Flexible layers

Laminating flexible layers within a foldable or rollable display requires excellent peel adhesion and very good bending properties. For some special substrates like silver nanowire, an OCA tape with good compatibility is required. Contact us to learn more about available solutions.

Assortment overview

	tesa® 693xx	tesa® 699xx	tesa® 698xx	tesa® 696xx	tesa® 71xx	tesa® 58xx	tesa® 694xx	tesa® 692xx	tesa® 6973xx	tesa® 6156x	tesa® 6153x
esign											
olor	Transparent	Transparent	Transparent	Transparent	Transparent	Transparent	Transparent	Transparent	Transparent	Transparent	Beige
уре	UV-curable	UV-curable	UV-curable	UV-curable	PSA	PSA	PSA	PSA	PSA	PSA	PSA
V-curing dosage [mj/cm²]	3,000	1,000	3,000	3,000	-	-	-	-	-	-	-
pecial features	High performance for thin design gaps	Curved design lamination	Outgassing resistant	Excellent gap filling	Mura resistance	Outgassing resistant	Lamination of films	UV-block	Foldable lamination	Low dK, Iow WVTR	Moisture blocking
15 μm									0 69730		
25 μm	0 69301	0 69901					0 69401		0 69731	0 61562	61531
50 μm	0 69302	0 69902	0 69802				0 69402		0 69732	0 61563	61533
75 μm									0 69733	0 61564	
100 μm	0 69304	0 69904	0 69804	0 69604			0 69404	0 69204			
125 μm				0 69605			0 69405				
150 μm		0 69906	0 69806	0 69606	0 7106	0 5806		0 69206			
175 μm				0 69607							
200 μm		0 69908	0 69808	0 69608	0 7108	0 5808		0 69208			
250 μm					0 7110	0 5810					
300 μm			0 69812	0 69612		0 5812					
Reference product	069304	0 69904	O 69804	0 69604	O 7108	0 5808	0 69404	o 69204	0 69732	o 61563**	● 61533**
Glass	11.8	12	10.2	11.1	8.6	9.1	6.9	6.9	2.4	5.0	6.5
Peel adhesion [N/cm; ultimate] PET	4.6	10.6	7.6	7.9	7.8	5.7	4.8	4.8	n.a.	3.3	6.0
PC	14.1	12.6	9.8	10.0	9.4	8.5	7.0	7	n.a.	4.7	6.8
Transmission [%]	>99	>99	>99	>99	>99	>99	>99	>99	>99	>99	n.a.
Haze [%]	<0.5	<0.5	<0.5	<0.5	<0.5	<0.5	<0.5	<0.5	<0.5	<0.5	n.a.
Refractive index	1.48	1.48	1.48	1.48	1.48	1.47	1.48	1.48	1.48	1.52	n.a.
Gap filling [%]	40	15	30	25	20	12	10	5	40	<10	<10
Dielectric constant ¹	5.7	4.58	4.7	4.5	5.3	6.7	4.9	4.9	5.6	2.56	2.92
G' [kPa] ²	348	1,620	250	130	69	124	107	106	32	550	Upon request
WVTR ³ [g/m ² *day]	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	0.9	0.45
Lag time ⁴ [h]	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	25	10,000

^{*} Further thicknesses might be available upon request.

O Transparent O Beige

^{**} Deviating thickness.

¹100 kHz

² 25°C, 1 Hz

³ 38°C, 90% rel. humidity, 1 mm

⁴ 60°C, 90% rel. humidity, 6.5 mm gap ⁵ WVTR after all getter is used up

Global presence



tesa® products prove their impressive quality day in, day out in demanding conditions and are regularly subjected to strict controls. All technical information and data above mentioned are provided to the best of our knowledge on the basis of our practical experience. They shall be considered as average values and are not appropriate for a specification. Therefore tesa SE can make no warranties, express or implied, including, but not limited to any implied warranty of merchantability or fitness for a particular purpose. The user is responsible for determining whether the tesa® product is fit for a particular purpose and suitable for the user's method of application. If you are in any doubt, our technical support staff will be glad to support you.

Your local contacts

German

Hugo-Kirchberg-Strasse 1 22848 Norderstedt | Germany +49-40-888-990 electronics@tesa.com

USA

111 W Evelyn Ave Suite 308 Sunnyvale, CA 94086 | USA +1-669-732-9809 electronics@tesa.com

Chi

No. 1, 2500 Lane Xiu Pu Road 201315 Pudong | Shanghai, China +86-21-6818-3110 electronics@tesa.com

Korea

City Air Tower, Office 1805
36 Teheran-ro 87-gil, Gangnam-gu
Seoul 06164 | Korea
+82-2-34300-100
electronics@tesa.com

Japa

1-27-6 Shirokane, Shirokane Takanawa Station Bldg 8F Minato-ku 108-0072 | Tokyo, Japan +81-3-6833-2300 electronics@tesa.com

Southeast Asia

9 North Buona Vista Drive 04-01 The Metropolis Tower 1 138588 | Singapore +65-6697-9888 electronics@tesa.com

Ind

301, 3rd Floor, Lakhani Centrium, Plot No 27, Sec 15, CBD Belapur, Navi Mumbai – 400614, Maharashtra +91-22-4741-9200 electronics@tesa.com

Vietn

Unit 210, 2nd Floor, V-Tower 649 Kim Ma Street, Ba Dinh District Hanoi | Vietnam +84 243 766 7800

+84 243 766 7800 electronics@tesa.com

38 Global presence – Contacts
Global presence – Contacts 39





Certifications

Our company is focused on international quality, environmental, and occupational safety standards.

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tesa SE

Phone: +49-40-888-990 tesa.com/company/locations

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